

ITV4030 15A Series











Description

ITV4030 Series is a chip type surface mountable device that can protect against both overcurrent and overcharging. It comprises a fuse element to ensure stable operation under normal electrical current and to cut off the current when overcurrent occurs. It also comprises a resistive heating element that could be used in combination with a voltage detecting means, such as IC and FET. When overvoltage is detected, the heating element is electrically excited to generate heat to blow the fuse element to achieve overvoltage protection.

Agency Approvals

AGENCY	AGENCY FILE NUMBER	AMPERE RANGE
c 'FL 'us	TBD	15 A
\triangle	TBD	15 A

Features

- Halogen Free
- Surface Mount
- Fast response
- Protection for both overcurrent and overcharging

Thermal Derating Characteristics

Ambient OperatingTemperature			
	25°C	40°C	60°C
Recommend Rated Current (A)	18.0	16.0	13.5

Applications

- Notebook
- Cell phone
- Camera
- Ultrabook
- Tablet PC

- Automotive applications
- Printer
- Security systems
- Power tools
- Ecall

Electrical Characteristics

Part Number Ordering Code	Ordania a Cada	I _{rated} (A)	V _{max} (Vdc)	I _{break} (A)	V _{OP} (V)	Resistance		Agency Approvals	
	Ordering Code					$R_{\scriptscriptstyle{heater}} \ (\Omega)$	$R_{fuse} \ (m\Omega)$	c FL °us	A
ITV4030L0415	ITV4030L0415NR	15	36	50	3.0 ~ 4.5	0.6 ~ 1.5	0.018	Χ	X
ITV4030L0815	ITV4030L0815NR	15	36	50	5.0 ~ 9.0	2.0 ~ 3.2	0.010	X	Χ
ITV4030L1215	ITV4030L1215NR	15	36	50	7.4 ~ 13.8	2.0 ~ 3.2	0.0085	X	X
ITV4030L1415	ITV4030L1415NR	15	36	50	10.5 ~ 19.6	11.2 ~ 20.0	0.010	X	X
ITV4030L2015	ITV4030L2015NR	15	36	50	14.4 ~ 23.5	17.9 ~ 29.1	1.0 ~ 3.0	Χ	X
Current Capacity		100% x I _{rated} No Melting							
CutTime		200% x I _{rated} < 1 min							
Interrupting Current		$5 \times I_{\text{rated}}$, power on 5 ms, power off 995 ms, 10000 cycles No Melting							

In operation voltage range, the fusing time is <1min.

I_{rated} = Current carrying capacity that is measured at 40°C thermal equilibrium condition

 I_{break} = The current that the fuse element is able to interrupt V_{max} = The maximum voltage that can be cut off by fuse

R_{heater} = The resistance of the heating element use = The resistance of the fuse element

Over Voltage Operation

Cells in series = Number of battery cells connected in series in the circuit for ITV device to protect.

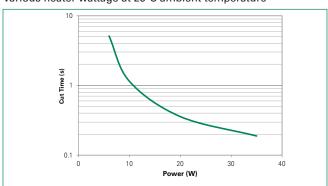
- Value specified is determined by using the PWB with 2mm*2oz copper traces, AWG18 covered wire, and 0.6mm glass epoxy PCB.
- Specifications are subject to change without notice

POLYSWITCH® Battery Protector

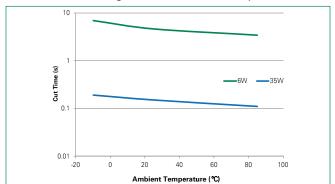
Surface Mount > ITV4030 Series

Cut Time by Heater Operation

Various heater wattage at 25°C ambient temperature

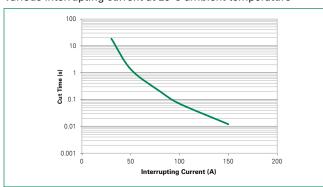


Constant heater wattage at various ambient temperature

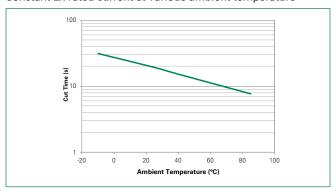


Cut Time by Current Operation

Various interrupting current at 25°C ambient temperature



Constant 2x rated current at various ambient temperature

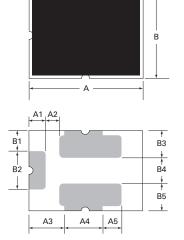


Environmental Specifications

Storage Temperature 0~35°C, ≤70%RH 3 months after shipment Operating Temperature -10°C to +65°C Operating Electric Power -25°C to +85°C/6~35W (applied to heater) Hot Passive Aging 100±5°C, 250 hours No structural damage and functional failure Humidity Aging 60°C±2°C, 90~95% R.H. 250 hours No structural damage and functional failure Cold Passive Aging -20±3°C, 500 hours No structural damage and functional failure Thermal Shock MIL-STD-202 Method 107G +125°C/-55°C, 100 times No structural damage and functional failure Solvent Resistance MIL-STD-202, Method 215 Vibration MIL-STD-883C, Method 2007.1, Condition A No structural damage and functional failure Moisture Level Sensitivity Level 1, J-STD-020C	-	
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Physical Dimension (mm)

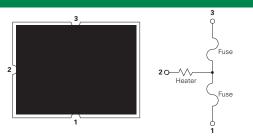


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1	4.00 . 0.0
Α	4.00 ± 0.3
В	3.00 ± 0.2
С	0.90 max
A1	0.58 ± 0.1
A2	0.50 ± 0.1
А3	1.26 ± 0.1
A4	1.35 ± 0.1
A5	0.67 ± 0.1
B1	0.80 ± 0.1
B2	1.44 ± 0.1
В3	1.03 ± 0.1
B4	0.96 ± 0.1
B5	1.03 ± 0.1

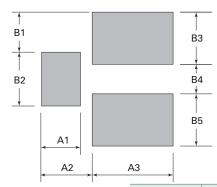
Physical Specifications

Material	Glass Epoxy PCB	
BaseThickness	0.6mm	
CopperThickness	0.07mm	
Covered Wire	AWG18	

Device Circuit



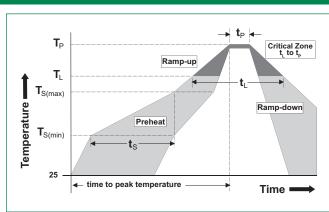
Board and Solder Layout Recommend (mm)



A1	1.20 ± 0.1
A2	1.55 ± 0.1
А3	2.40 ± 0.1
B1	1.20 ± 0.1
B2	1.60 ± 0.1
В3	1.55 ± 0.1
B4	0.90 ± 0.1
B5	1.55 ± 0.1

Soldering Parameters

Average Ramp-Up Rate (Ts _{max} to TP) 3°C/second max				
Preheat	Temperature Min (Ts _{min})	150°C		
	Temperature Max (Ts _{max})	200°C		
	Time (Ts _{min} to Ts _{max})	60-120 seconds		
Time maintained above:	Temperature (T _L)	217°C		
	Time (t _L)	60-105 seconds		
Peak Temperature (T	Peak Temperature (T _P) 255°C			
Time within 5°C of actual Peak Temperature (t _p) 5 seconds ma				
Ramp-Down Rate	6°C/second max.			
Time 25°C to Peak Te	8 minutes max.			

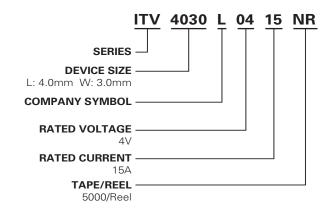


- All temperature refer to topside of the package, measured on the package body surface
- If reflow temperature exceeds the recommended profile, devices may not meet the performance requirements
- Recommended reflow methods: IR, vapor phase oven, hot air oven, ${\rm N_2}$ environment for lead
- Recommended maximum paste thickness is 0.25mm (0.010inch)
- Devices can be cleaned using standard industry methods and solvents
- Devices can be reworked using the standard industry practices

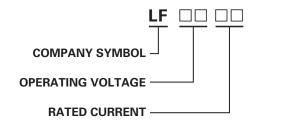
POLYSWITCH® Battery Protector

Surface Mount > ITV4030 Series

Part Numbering System



Part Marking System



Pac	

Part Number	Tape and Reel Quantity	
ITV4030LXX15	5,000	

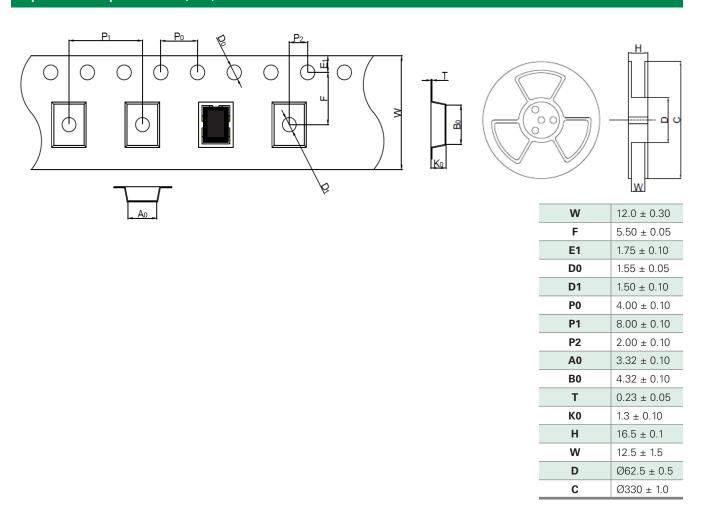
Installation and Handling Guidelines

- Before and after mounted, the ultrasonic-cleaning or immersion-cleaning must not be done to ITV device. The flux on element would flow, and it would not be satisfied its specification when cleaning is done. In addition, a similar influence happens when the product comes in contact with cleaning solution. These products after cleaning will not be guaranteed.
- Silicone-based oils, oils, solvents, gels, electrolytes, fuels, acids, and similar will adversely affect the properties of ITV devices, and shall not be used or applied.
- Please DO NOT reuse the ITV device removed by the soldering process.
- ITV devices are secondary protection devices and are used solely for sporadic, accidental overcurrent or overtemperature error condition, and shall NOT be used if or when constant or repeated fault conditions (such fault conditions may be caused by, among others, incorrect pin-connection of a connector) or over-extensive trip events may occur.
- Operation over the maximum rating or other forms of improper use may cause failure, arcing, flame and/or other damage to the ITV devices.

- The performance of ITV devices will be adversely affected if they are improperly used under electronic, thermal and/or mechanical procedures and/or conditions non-conformant to those recommended by manufacturer.
- Customers shall be responsible for determining whether it is necessary to have back-up, failsafe and/or fool-proof protection to avoid or minimize damage that may result from extra-ordinary, irregular function or failure of ITV devices.
- There should be minimum of 0.1mm spacing between ITV and surrounding compounds, to maintain the product characteristics and avoid damage other surrounding compounds.
- This product is designed and manufactured only for general-use of electronics devices. We do not recommend that it is used for the applications military, medical and so on which may cause direct damages on life, bodies or properties.



Tape and Reel Specifications (mm)



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